TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π -MOS VI)

2SK4107

Switching Regulator Applications

• Low drain-source ON resistance : $R_{DS (ON)} = 0.33 \Omega (typ.)$

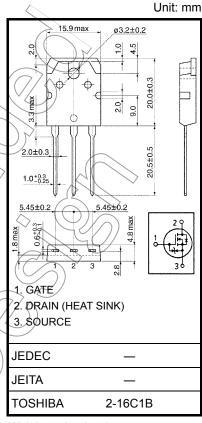
• High forward transfer admittance : |Y_{fs}| = 8.5 S (typ.)

• Low leakage current : $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 500 \text{ V)}$

• Enhancement mode : $V_{th} = 2.0 \text{ to } 4.0 \text{ V } (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

				A
Characteri	stic	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	500	$(\checkmark\cancel{v}\))$
Drain-gate voltage (Ro	$_{\rm SS}$ = 20 k Ω)	V_{DGR}	500	$) \geqslant$
Gate-source voltage		V _{GSS}	±30	×
Drain current	DC (Note 1)	ID	15	<i>></i>
	Pulse (Note 1)	I_{DP}	60	Α
Drain power dissipation	r (Tc = 25°C)	P_{D}	150	W
Single-pulse avalanche	e energy (Note 2)	E _{AS}	765	m m
Avalanche current		IAR (15	A
Repetitive avalanche e	nergy (Note 3)	EAR	15	mJ
Channel temperature		((T _{ch}	150	//°c
Storage temperature ra	inge	T _{stg}	-55~150	Ş)



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic Symbol	Max	Unit
Thermal resistance, channel to case	0.833	°C/W
Thermal resistance, channel to ambient R _{th (ch-a)}	50	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 5.78 mH, R_G = 25 Ω , I_{AR} = 15 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

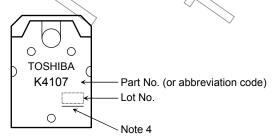
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bro	eakdown voltage	V (BR) GSS	I _G = ±10 μA, V _{DS} = 0 V	±30	_	_	V
Drain cutoff curr	rent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	/	_	100	μΑ
Drain-source br	reakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	_		٧
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) >-	4.0	٧
Drain-source O	N resistance	R _{DS (ON)}	V _{GS} = 10 V, I _D = 7.0 A	> <u>\</u>	0.33	0.4	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 7.0 A	4.0	8.5		S
Input capacitano	ce	C _{iss}			2450	_	
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	_	15	_	pF
Output capacita	nce	Coss		_	220		
Switching time	Rise time	t _r	V _{GS} _{OV} I _D =7A V _{out}	- (50	/\rangle 1 \rangle	
	Turn-on time	t _{on}	$R_L=30\Omega$		990) –	20
	Fall time	t _f	V = 910V	7(5)	45	_	ns
	Turn-off time	t _{off}	$V_{DD} = 210V$ Duty $\leq 1\%$, $t_{W} = 10\mu s$) –	175	_	
Total gate charg		Qg		_	48	_	
Gate-source ch	arge	Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 15 \text{ A}$	_	26	_	nC
Gate-drain ("Mi	ller") charge	Q _{gd}		_	22	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

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Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	JOR	<u> </u>	_	_	15	Α
Pulse drain reverse current (Note 1)	\ I _{DRP}	-	-	_	60	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 15 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 15 A, V _{GS} = 0 V dI _{DR} / dt = 100 A / μs		1050	_	ns
Reverse recovery charge	Qrr		-	13	_	μC

Marking

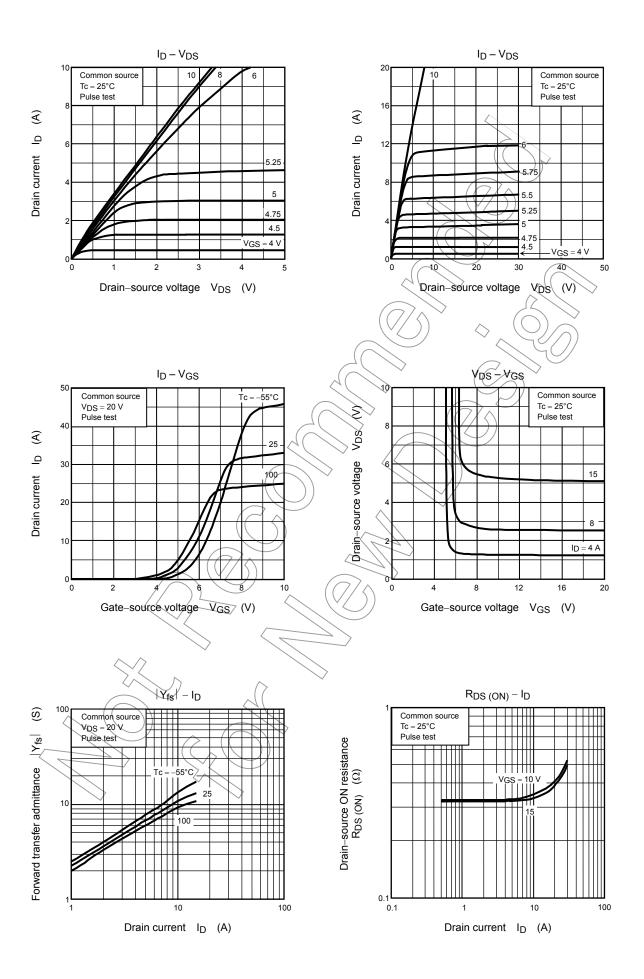


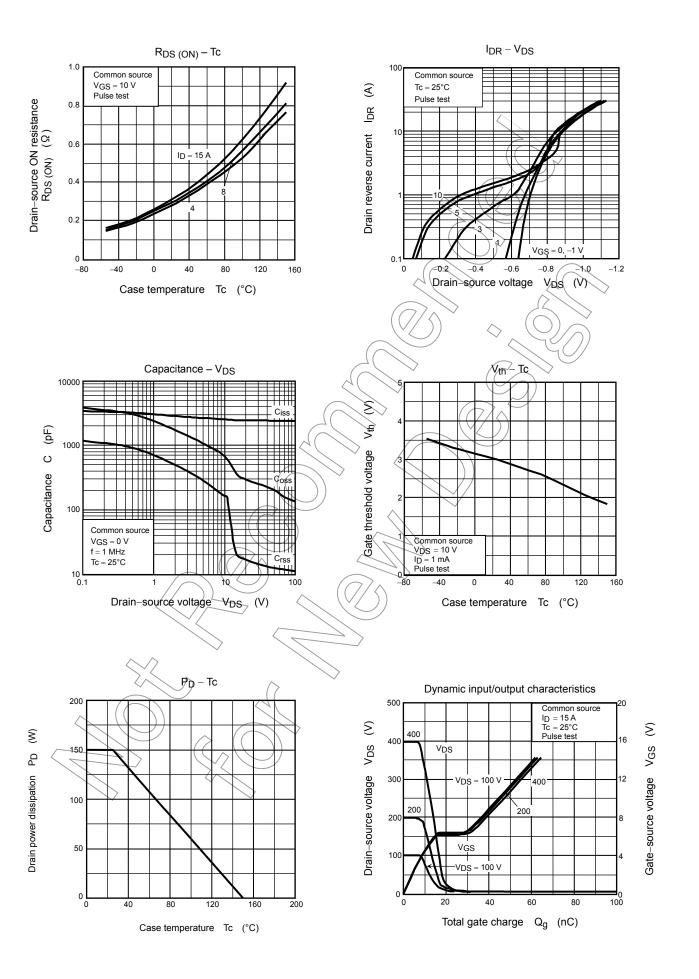
Note 4: A line under a Lot No. identifies the indication of product Labels.

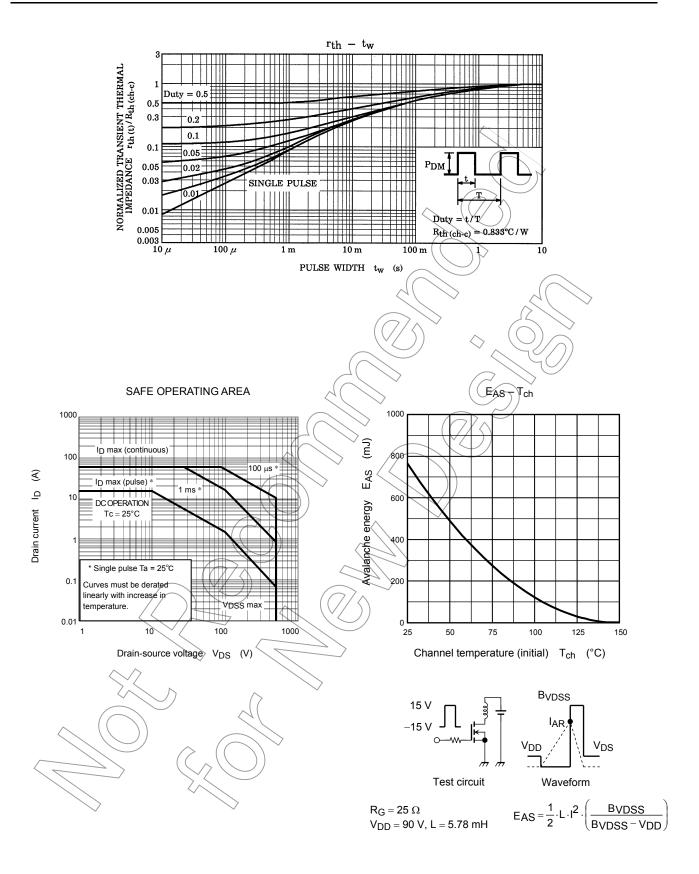
Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

2 2009-09-29







5 2009-09-29

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